



PNP Silicon Low-Power Transistor Qualified per MIL-PRF-19500/485

Qualified Levels: JAN, JANTX, JANTXV and JANS

DESCRIPTION

This family of 2N5415S and 2N5416S epitaxial planar transistors are military qualified up to a JANS level for high-reliability applications. These devices are also available in the longer leaded TO-5 and low profile U4 and UA packaging.

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FEATURES

- JEDEC registered 2N5415 through 2N5416 series
- JAN, JANTXV, and JANS qualifications are available per MIL-PRF-19500/485.
 (See part nomenclature for all available options.)
- · RoHS compliant commercial version

APPLICATIONS / BENEFITS

- General purpose transistors for low power applications requiring high frequency switching.
- Low package profile.
- Military and other high-reliability applications.



TO-205AD (TO-39) Package

Also available in:

TO-5 package (long-leaded) 2N5415 – 2N5416

U4 package (surface mount) 2N5415U4 – 2N5416U4

UA package (surface mount) <u>2N5415UA − 2N5416UA</u>

MAXIMUM RATINGS @ TA = +25 °C unless otherwise noted

Parameters / Test Conditions		2N5415S	2N5416S	Unit
Collector-Emitter Voltage	V_{CEO}	200	300	V
Collector-Base Voltage	V _{CBO}	200 350		V
Emitter-Base Voltage	V _{EBO}	6.0 6.0		V
Collector Current	Ic	1.0 1.0		Α
Operating & Storage Junction Temperature Range	T_J, T_{stg}	-65 to +200		°C
Thermal Resistance Junction-to-Ambient	$R_{\Theta JA}$	234		°C/W
Thermal Resistance Junction-to-Case	$R_{ heta JC}$	17.5		°C/W
Total Power Dissipation @ $T_A = +25 ^{\circ}C^{(1)}$ @ $T_C = +25 ^{\circ}C^{(2)}$	P _T	0.75 10		W

Notes: 1. Derate linearly 4.29 mW/°C for T_A > +25 °C.

2. Derate linearly 57.2 mW/°C for $T_C > +25$ °C.

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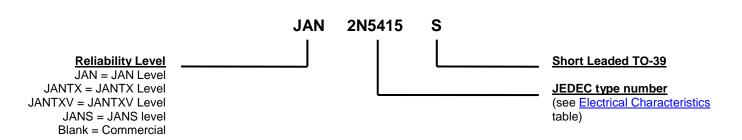
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MECHANICAL and PACKAGING

- CASE: Hermetically sealed, kovar base, nickel cap
- TERMINALS: Gold plated kovar and solder dip (Sn63/Pb37) on JAN, JANTX, and JANTXV versions. NOTE: Solder dipped versions are not RoHS compliant.
- MARKING: Part number, date code, manufacturer's ID and serial number
- POLARITY: PNP
- WEIGHT: Approximately 1.064 grams
- See <u>Package Dimensions</u> on last page.

PART NOMENCLATURE



SYMBOLS & DEFINITIONS			
Symbol	Definition		
C_obo	Common-base open-circuit output capacitance		
I _{CEO}	Collector cutoff current, base open		
I _{CEX}	Collector cutoff current, circuit between base and emitter		
I _{EBO}	Emitter cutoff current, collector open		
h_{FE}	Common-emitter static forward current transfer ratio		
V_{CEO}	Collector-emitter voltage, base open		
V_{CBO}	Collector-emitter voltage, emitter open		
V_{EBO}	Emitter-base voltage, collector open		



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C, unless otherwise noted

OFF CHARACTERISTICS

Parameters / Test Conditions		Symbol	Min.	Max.	Unit
Collector-Emitter Breakdown Voltage					
$I_C = 50 \text{ mA}, I_B = 5 \text{ mA},$	2N5415S	$V_{(BR)CEO}$	200		V
L = 25 mH; $f = 30 - 60 Hz$	2N5416S		300		
Emitter-Base Cutoff Current		1		20	
$V_{EB} = 6.0 \text{ V}$		I _{EBO}		20	μA
Collector-Emitter Cutoff Current					
$V_{CE} = 200 \text{ V}, V_{BE} = 1.5 \text{ V}$	2N5415S	I _{CEX}		50	μΑ
$V_{CE} = 300 \text{ V}, V_{BE} = 1.5 \text{ V}$	2N5416S				
Collector-Emitter Cutoff Current					
V _{CE} = 150 V	2N5415S	I _{CEO1}		50	μΑ
$V_{CE} = 250 \text{ V}$	2N5416S				
Collector-Emitter Cutoff Current					
V _{CE} = 200 V	2N5415S	I _{CEO2}		1	mΑ
$V_{CE} = 300 \text{ V}$	2N5416S				
Collector-Base Cutoff Current					
V _{CB} = 175 V	2N5415S	I _{CBO1}		50	μΑ
$V_{CB} = 280 \text{ V}$	2N5416S				
$V_{CB} = 200 \text{ V}$	2N5415S	I _{CBO2}		500	μА
$V_{CB} = 350 \text{ V}$	2N5416S	ICBO2		300	μΛ
$V_{CB} = 175 \text{ V}, T_A = +150 {}^{\circ}\text{C}$	2N5415S	Longo		1	mΑ
$V_{CB} = 280 \text{ V}, T_A = +150 {}^{\circ}\text{C}$	2N5416S	I _{CBO3}		ı	111/-

ON CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Forward-Current Transfer Ratio $I_C = 50$ mA, $V_{CE} = 10$ V $I_C = 1$ mA, $V_{CE} = 10$ V $I_C = 50$ mA, $V_{CE} = 10$ V, $T_A = +150$ °C	h _{FE}	30 15 15	120	
Collector-Emitter Saturation Voltage I _C = 50 mA, I _B = 5 mA	V _{CE(sat)}		2.0	V
Base-Emitter Voltage Non-Saturation $I_C = 50 \text{ mA}, V_{CE} = 10 \text{ V}$	V _{BE}		1.5	V

DYNAMIC CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Magnitude of Common Emitter Small-Signal Short-Circuit Forward Current Transfer Ratio $I_C = 10$ mA, $V_{CE} = 10$ V, $f = 5$ MHz	h _{fe}	3	15	
Small-signal short Circuit Forward-Current Transfer Ratio I _C = 5 mA, V _{CE} = 10 V, f ≤ 1 kHz	h _{fe}	25		
Output Capacitance $V_{CB} = 10 \text{ V}, I_E = 0, 100 \text{ kHz} \le f \le 1 \text{ MHz}$	C _{obo}		15	pF



ELECTRICAL CHARACTERISTICS @ T_A = +25 °C unless otherwise noted. (continued)

SWITCHING CHARACTERISTICS

Parameters / Test Conditions	Symbol	Min.	Max.	Unit
Turn-On Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = 5 \text{ mA}$	t _{on}		1	μs
Turn-Off Time $V_{CC} = 200 \text{ V}, I_C = 50 \text{ mA}, I_{B1} = I_{B2} = 5 \text{ mA}$	t _{off}		10	μs

SAFE OPERATING AREA (See SOA graph below and MIL-STD-750, method 3053)

DC Tests

 T_C = +25 °C, t_P = 0.4 s, 1 Cycle

Test 1

 $V_{CE} = 10 \text{ V}, I_{C} = 1 \text{ A}$

Test 2

 $V_{CE} = 100 \text{ V}, I_{C} = 100 \text{ mA}$

Test 3

 $V_{CE} = 200 \text{ V}, I_{C} = 24 \text{ mA } (2N5415 \text{S only})$

Test 4

 $V_{CE} = 300 \text{ V}, I_{C} = 10 \text{ mA} (2N5416S \text{ only})$



Maximum Safe Operating Area (T_J = 200 °C)



GRAPHS

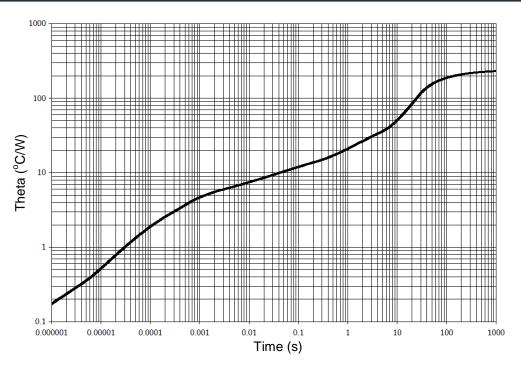


FIGURE 1
Thermal impedance graph (R_{OJA})

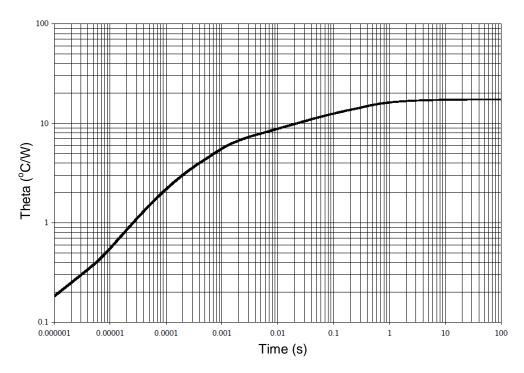
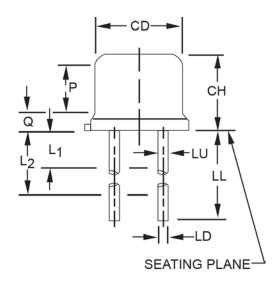


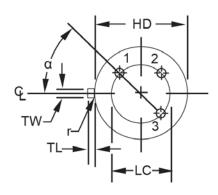
FIGURE 2
Thermal impedance graph (R_{OJA})

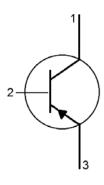


PACKAGE DIMENSIONS



Dimensions						
Symbol	In	ch	Millimeters		Notes	
	Min	Max	Min	Max		
CD	0.305	0.335	7.75	8.51		
CH	0.240	0.260	6.10	6.60		
HD	0.335	0.370	8.51	9.40		
LC	0.20	0 TP	5.08	3 TP	6	
LD	0.016	0.021	0.41	0.53	7, 8	
LL	0.500	0.750	12.70	19.05	7, 8	
LU	0.016	0.019	0.41	0.48	7, 8	
L ₁	-	0.050	-	1.27	7, 8	
L ₂	0.250	-	6.35	-	7, 8	
Q	-	0.050	-	1.27	5	
TL	0.029	0.045	0.74	1.14	4	
TW	0.028	0.034	0.71	0.86	3	
r	-	0.010	-	0.25	10	
α	45°	TP	45° TP		6	
Р	0.100	-	2.54	-		





NOTES:

- 1. Dimensions are in inches.
- 2. Millimeters are given for information only.
- 3. Beyond r (radius) maximum, TW shall be held for a minimum length of 0.011 (0.28 mm).
- 4. Dimension TL measured from maximum HD.
- 5. Body contour optional within zone defined by HD, CD, and Q.
- Leads at gauge plane 0.054 +0.001 -0.000 inch (1.37 +0.03 -0.00 mm) below seating plane shall be within 0.007 inch (0.18 mm) radius of true position (TP) at maximum material condition (MMC) relative to tab at MMC. This device may be measured by direct methods.
- 7. Dimension LU applies between L1 and L2. Dimension LD applies between L2 and minimum. Diameter is uncontrolled in L1 and beyond LL minimum.
- 8. All three leads.
- 9. The collector shall be internally connected to the case.
- 10. Dimension r (radius) applies to both inside corners of tab.
- 11. In accordance with ASME Y14.5M, diameters are equivalent to Φx symbology.
- 12. Lead 1 = emitter, lead 2 = base, lead 3 = collector.

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